



AF/IFW

**EXPEDITED PROCEDURE – EXAMINING GROUP 2811**

**S/N 10/673,605**

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant:	Kum Foo Leong et al.	Examiner:	Nitin Parekh
Serial No.:	10/673,605	Group Art Unit:	2811
Filed:	September 29, 2003	Docket No.:	884.A68US1
Title:	DIFFUSION BARRIER LAYER FOR LEAD FREE PACKAGE SUBSTRATE		
Assignee:	Intel Corporation	Customer No.:	21186

**AMENDMENT & RESPONSE UNDER 37 C.F.R. 1.116**

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Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

In response to the Final Office Action mailed December 21, 2004, please amend the application as follows: